

#### 1000V 15A APT15DQ100BG APT15DQ100SG

Pb Free Terminal Finish.

# ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

#### PRODUCT APPLICATIONS

- Anti-Parallel Diode -Switchmode Power Supply -Inverters
- Free Wheeling Diode -Motor Controllers -Converters -Inverters
- Snubber Diode

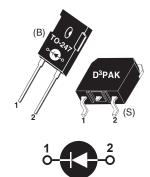
• PFC

#### PRODUCT FEATURES

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- · Popular TO-247 Package
- · Low Forward Voltage
- · Low Leakage Current
- Avalanche Energy Rated

#### **PRODUCT BENEFITS**

- Low Losses
- · Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density



1 - Cathode 2 - Anode Back of Case - Cathode

#### **MAXIMUM RATINGS**

#### All Ratings: $T_{C} = 25^{\circ}C$ unless otherwise specified. APT15DQ100(B/S)G Symbol **Characteristic / Test Conditions** UNIT $\mathsf{V}_\mathsf{R}$ Maximum D.C. Reverse Voltage $V_{RRM}$ Maximum Peak Repetitive Reverse Voltage 1000 Volts $V_{RWM}$ Maximum Working Peak Reverse Voltage Maximum Average Forward Current ( $T_{C} = 126^{\circ}C$ , Duty Cycle = 0.5) 15 I<sub>F(AV)</sub> RMS Forward Current (Square wave, 50% duty) 29 Amps I<sub>F(RMS)</sub> Non-Repetitive Forward Surge Current ( $T_1 = 45^{\circ}C$ , 8.3ms) 80 $I_{FSM}$ 20 E<sub>AVL</sub> Avalanche Energy (1A, 40mH) mJ -55 to 175 T<sub>J</sub>,T<sub>STG</sub> Operating and StorageTemperature Range °C Τ<sub>L</sub> 300 Lead Temperature for 10 Sec.

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		MIN	ТҮР	МАХ	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 15A		2.5	3.0	
		I <sub>F</sub> = 30A		3.06		Volts
		I <sub>F</sub> = 15A, T <sub>J</sub> = 125°C		1.92		
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = 1000V			100	- μΑ
		V <sub>R</sub> = 1000V, T <sub>J</sub> = 125°C			500	
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			12		pF

#### DYNAMIC CHARACTERISTICS

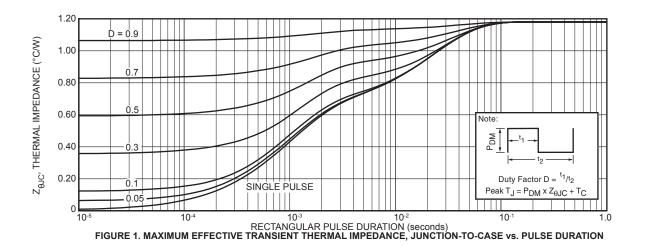
#### APT15DQ100(B/S)G

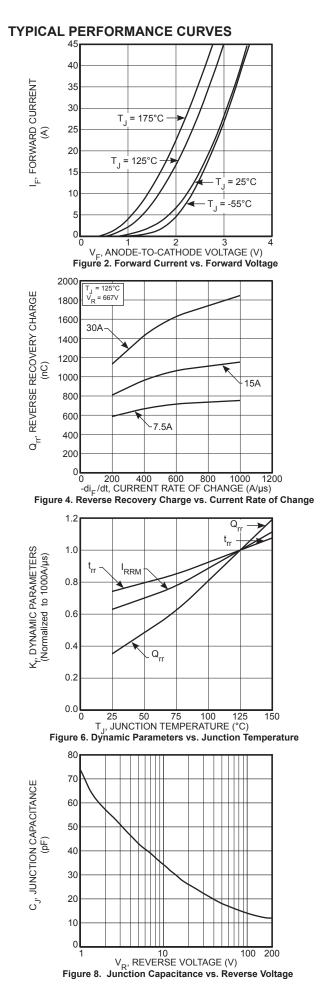
Symbol	Characteristic	Test Conditions	MIN	ТҮР	MAX	UNIT
t <sub>rr</sub>	Reverse Recovery Time $I_F = 1A$ , $di_F/dt = -100A/\mu s$ , $V_R = 30V$ , $T_J = 25^{\circ}C$		-	20		nc
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 15A, di <sub>F</sub> /dt = -200A/μs V <sub>R</sub> = 667V, T <sub>C</sub> = 25°C	-	235		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	185		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	3	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 15A, di <sub>F</sub> /dt = -200A/μs V <sub>R</sub> = 667V, T <sub>C</sub> = 125°C	-	300		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	810		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	6	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 15A, di <sub>F</sub> /dt = -1000A/µs V <sub>R</sub> = 667V, T <sub>C</sub> = 125°C	-	125		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	1150		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	19		Amps

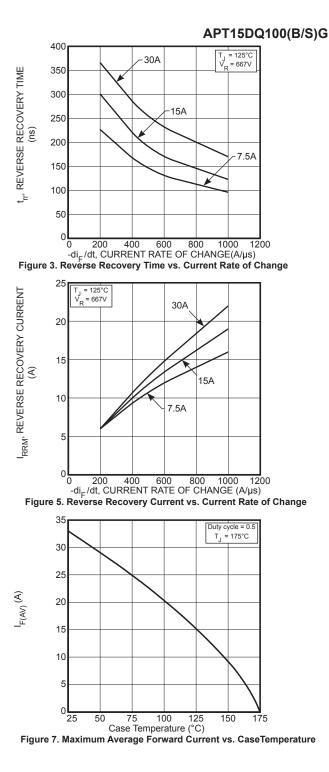
#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	ТҮР	MAX	UNIT
R <sub>θJC</sub>	Junction-to-Case Thermal Resistance			1.18	°C/W
W <sub>T</sub>	Package Weight		0.22		οz
			5.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

Microsemi reserves the right to change, without notice, the specifications and information contained herein.







053-4225 Rev D 1-2020

0.25 I<sub>RRM</sub>

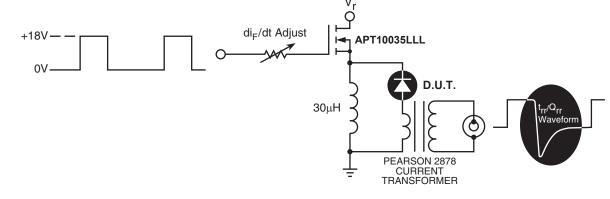


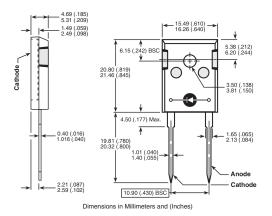
Figure 9. Diode Test Circuit

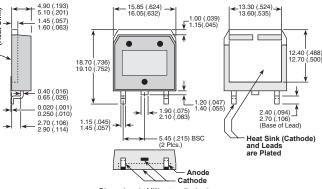
Zero

- I<sub>F</sub> Forward Conduction Current
   di<sub>E</sub>/dt Rate of Diode Current Change Through Zero Crossing.
- 3 I<sub>RBM</sub> Maximum Reverse Recovery Current.
  - t<sub>rr</sub> Reverse Recovery Time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I<sub>RRM</sub> and 0.25•I<sub>RRM</sub> passes through zero.
- 5 Q<sub>rr</sub> Area Under the Curve Defined by I<sub>RRM</sub> and t<sub>rr</sub>.

Figure 10, Diode Reverse Recovery Waveform and Definitions

### **TO-247 Package Outline**







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# D<sup>3</sup>PAK Package Outline

e3 100% Sn

4

5

3

2

Dimensions in Millimeters (Inches)

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